INTEGRATED CIRCUITS

DATA SHEET

MAX6352-XX

Dual voltage microprocessor supervisory IC

Product data Supersedes data of 2003 Aug 01





Dual voltage microprocessor supervisory IC

MAX6352-XX

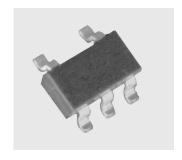
GENERAL DESCRIPTION

The MAX6352-XX microprocessor (μP) supervisory IC has dual power supply voltage monitoring in which all reset outputs are asserted when either power supply voltage falls below its preset threshold reset level. The reset state is guaranteed valid as long as either $V_{DD}1$ or $V_{DD}2$ is above +1 V.

The MAX6352-XX has an active-LOW debounced manual reset input and an open drain, active-LOW RESET output. It is offered in specific reset threshold levels as shown in the Voltage Threshold Levels table. The MAX6352-XX is available in the small outline 5-lead package (SOT23-5; SOP003) and operates over the extended temperature range of –40 °C to +85 °C.

FEATURES

- Precision monitoring of multiple +1.8 V, +2.5 V, 3.0 V, +3.3 V, and +5 V power supply voltages
- Factory set precision reset thresholds
- 20 μA supply current
- 100 ms power-on-reset delay time
- Debounced manual reset input: TTL/CMOS compatible
- Guaranteed parameters over temperature
- Guaranteed RESET valid to V_{DD}1 or V_{DD}2 =1 V



- Power supply transient immunity
- Small 5-pin SOT23 package
- Low cost, high reliability solution

APPLICATIONS

- Computers and controllers
- Portable/battery-powered equipment
- Multi-voltage systems
- Industrial and intelligent instrumentation

SIMPLIFIED DEVICE DIAGRAM

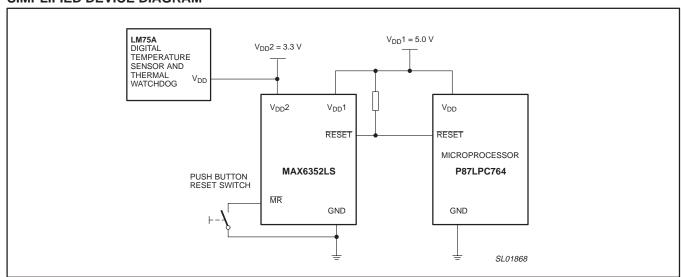


Figure 1. Simplified device diagram.

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ORDERING INFORMATION

TYPE NUMBER	PACKAGE	TEMPERATURE		
I TPE NUMBER	NAME	DESCRIPTION	VERSION	RANGE
MAX6352- XX D	SOT23-5	plastic small outline package; 5 leads; body width 1.5 mm SOP003		–40 °C to +85 °C

NOTE:

The device has 1 standard voltage output options, indicated by the **XX** on the Type Number. Additional voltage options may be available; see Table 1.

Table 1. Voltage threshold levels

XX	V _{CC} 1 NOMINAL THRESHOLD VOLTAGE (V)	V _{CC} 2 NOMINAL THRESHOLD VOLTAGE (V)						
Standard versions (note 1)								
SV	2.93	1.58						
Non-standard vers	sions (note 2)							
LT	4.63	3.08						
LS	4.63	2.93						
LR	4.63	2.63						
MT	4.38	3.08						
MS	4.38	2.93						
MR	4.38	2.63						
TY	3.08	2.19						
TV	3.08	1.58						
SZ	2.93	2.32						
SY	2.93	2.19						
SW	2.93	1.67						
TZ	3.08	2.32						
TW	3.08	1.67						
UW	2.78	1.67						
UV	2.78	1.58						
RW	2.63	1.67						
RV	2.63	1.58						

NOTES:

- 1. Sample stock is available only in standard versions.
- 2. Contact factory for availability of non-standard versions.

PIN CONFIGURATION

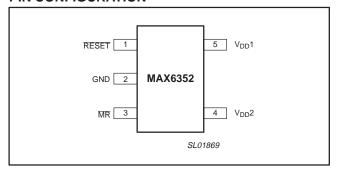


Figure 2. Pin configuration.

PIN DESCRIPTION

PIN	SYMBOL	DESCRIPTION
1	RESET	Active-LOW Reset Output. Open drain output configuration.
2	GND	Ground
3	MR	Manual Reset Input. Pull LOW to assert a reset. $\overline{\text{RESET}}$ is active-LOW as long as $\overline{\text{MR}}$ is LOW and remains LOW for the timeout period after $\overline{\text{MR}}$ goes HIGH. If not used connect to $V_{DD}1$ or leave floating.
4	V _{DD} 2	Supply input. Powers the device when it is above V _{DD} 1 and monitors its own voltage
5	V _{DD} 1	Supply input. Powers the device when it is above V _{DD} 2 and monitors its own voltage.

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MAXIMUM RATINGS

SYMBOL	PARAMETER	MIN.	MAX.	UNIT
$V_{DD}1, V_{DD}2$	Supply voltage	-0.3	+6.0	V
RESET	RESET output	-0.3	+6.0	V
	Input/output current, all pins		20	mA
Р	Continuous Power Dissipation (derate 7.1 mW/°C above T _{amb} = 70 °C)		571	mW
T _{amb}	Ambient operating temperature range	-40	+85	°C
Tj	Maximum junction temperature		150	°C
T _{stg}	Storage temperature range	-65	150	°C

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ELECTRICAL CHARACTERISTICS

 $T_{amb} = 25~^{\circ}\text{C},~V_{DD}1 = V_{DD}2 = +1.2~V~to~+5.5~V,~T_{amb} = ~-40~^{\circ}\text{C}~to~+85~^{\circ}\text{C}~(Note~1)~unless~otherwise~specified.$

SYMBOL	PARAMETE	R	CONDITIONS	MIN.	TYP.	MAX.	UNIT
V _{DD} 1,	Supply voltage		$T_{amb} = 0 ^{\circ}\text{C} \text{ to } +70 ^{\circ}\text{C}$	1.0	_	5.5	
$V_{DD}2$	Supply current		$T_{amb} = -40 ^{\circ}\text{C} \text{ to } +85 ^{\circ}\text{C}$	1.2	_	5.5	
I _{DD} 1, I _{DD} 2	Supply current		$V_{DD}1 = 5.5 \text{ V}, V_{DD}2 = 3.6 \text{ V};$ all I/O pins open	-	20	50	μА
V _{th} 1	V _{DD} 1 threshold (Note 1)	MAX6352-L_	T _{amb} = +25 °C	4.54	4.63	4.72	V
			$T_{amb} = -40 ^{\circ}\text{C} \text{ to } +85 ^{\circ}\text{C}$	4.5	_	4.75	V
		MAX6352-M_	T _{amb} = +25 °C	4.3	4.38	4.46	V
			$T_{amb} = -40 ^{\circ}\text{C} \text{ to } +85 ^{\circ}\text{C}$	4.25	_	4.50	V
		MAX6352-T_	T _{amb} = +25 °C	3.03	3.08	3.14	V
			$T_{amb} = -40 ^{\circ}\text{C} \text{ to } +85 ^{\circ}\text{C}$	3.00	_	3.15	V
		MAX6352-S_	T _{amb} = +25 °C	2.88	2.93	2.98	V
			$T_{amb} = -40 ^{\circ}\text{C} \text{ to } +85 ^{\circ}\text{C}$	2.85	_	3.00	V
		MAX6352-U_	T _{amb} = +25 °C	2.74	2.78	2.82	V
			$T_{amb} = -40 ^{\circ}\text{C} \text{ to } +85 ^{\circ}\text{C}$	2.70	_	2.85	V
		MAX6352-R_	T _{amb} = +25 °C	2.58	2.63	2.68	V
			$T_{amb} = -40 ^{\circ}\text{C} \text{ to } +85 ^{\circ}\text{C}$	2.55	_	2.70	V
V _{th} 2	V _{th} 2 V _{DD} 2 threshold (Note 1)	MAX6352T	T _{amb} = +25 °C	3.03	3.08	3.14	V
			$T_{amb} = -40 ^{\circ}\text{C} \text{ to } +85 ^{\circ}\text{C}$	3.00	_	3.15	V
		MAX6352S	T _{amb} = +25 °C	2.88	2.93	2.98	V
			$T_{amb} = -40 ^{\circ}\text{C} \text{ to } +85 ^{\circ}\text{C}$	2.85	_	3.00	V
		MAX6352R	T _{amb} = +25 °C	2.58	2.63	2.68	V
			$T_{amb} = -40 ^{\circ}\text{C} \text{ to } +85 ^{\circ}\text{C}$	2.55	_	2.70	V
		MAX6352Z	T _{amb} = +25 °C	2.28	2.32	2.35	V
			$T_{amb} = -40 ^{\circ}\text{C} \text{ to } +85 ^{\circ}\text{C}$	2.25	_	2.38	V
		MAX6352Y	T _{amb} = +25 °C	2.16	2.19	2.22	V
			$T_{amb} = -40 ^{\circ}\text{C} \text{ to } +85 ^{\circ}\text{C}$	2.13	_	2.25	V
		MAX6352W	T _{amb} = +25 °C	1.64	1.67	1.70	V
			$T_{amb} = -40 ^{\circ}\text{C} \text{ to } +85 ^{\circ}\text{C}$	1.62	_	1.71	V
		MAX6352V	T _{amb} = +25 °C	1.55	1.58	1.61	V
			$T_{amb} = -40 ^{\circ}\text{C} \text{ to } +85 ^{\circ}\text{C}$	1.53	_	1.62	V
ΔV _{th} /°C	Reset threshold temperat	ure coefficient		_	20	_	ppm/°C
V _{hys}	Reset threshold hysteresi	S		_	V _{th} /500	_	V
	V _{CC} to Reset delay		100 mV overdrive	_	20	_	μs
t _{RP}	Reset timeout period		$V_{DD}1 > V_{th}1(MAX); V_{DD}2 > V_{th}2(MAX)$	100	180	280	ms
V _{OL}	RESEToutput voltage LO	W	$V_{DD}1 \text{ or } V_{DD}2 \ge 2.7 \text{ V; } I_{SINK} = 1.2 \text{ mA}$	_	_	0.3	
			$V_{DD}1 \text{ or } V_{DD}2 \ge 4.5 \text{ V; } I_{SINK} = 3.2 \text{ mA}$	_	_	0.4	.,
			V_{DD} 1 or V_{DD} 2 ≥ 1 V; I_{SINK} = 50 μA; I_{amb} = 0 °C to +70 °C	_	-	0.3	V
			V_{DD} 1 or V_{DD} 2 \geq 1.2 V; I_{SINK} = 50 μ A; I_{amb} = -40 °C to +85 °C	_	_	0.3	

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ELECTRICAL CHARACTERISTICS (continued)

 T_{amb} = 25 °C, V_{DD} 1 = V_{DD} 2 = +1.2 V to +5.5 V, T_{amb} = -40 °C to +85 °C (Note 1) unless otherwise specified.

SYMBOL	PARAMETE	R	CONDITIONS	MIN.	TYP.	MAX.	UNIT
Manual Res	et Input						
V _{IL}	MR input voltage	MAX6352-L_,	$V_{DD}1 > V_{th}1(MAX)$	_	_	0.8	V
V _{IH}		MAX6352-M_		2.3	_	_	V
V_{IL}		MAX6352Y	$V_{DD}1 > V_{th}1(MAX)$	_	_	$0.3 \times V_{DD}$	V
V_{IH}				$0.7 \times V_{DD}$	_	_	V
	MR pull-up resistance			32	63.5	100	kΩ
t _{MR}	MR minimum pulse width			1	_	_	μs
	MR glitch rejection			-	100	_	ns
t _{MD}	MR to Reset delay			_	0.1	_	μs

NOTES:

- 1. Overtemperature limits are guaranteed by design and are not production tested.
- The reset output is guaranteed to be in the correct state if either V_{DD}1 or V_{DD}2 is within its specified window of operation.
 The reset output is asserted if either V_{DD}1 or V_{DD}2 falls below its associated threshold voltage.

Dual voltage microprocessor supervisory IC

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TECHNICAL DISCUSSION

The MAX6352-XX microprocessor (μP) supervisory IC provides system protection by monitoring two power supply voltages and asserting a reset signal if either supplies falls below the specified threshold (see Figure 3). The MAX6352-XX has an active-LOW open drain output. The output reset state is guaranteed to remain valid as long as either V_{DD}1 or V_{DD}2 is above +1 V. Power for the MAX6352-XX is sourced from whichever is the higher voltage: V_{DD}1 or V_{DD}2.

Threshold levels

All available power supply input voltage threshold level combinations are indicated in Table 1, "Voltage threshold levels".

Manual Reset

The manual reset input, \overline{MR} is active-LOW logic. It allows the RESET to be asserted by a pushbutton switch. A mechanical pushbutton switch is effectively debounced by the glitch filter. The typical glitch rejection is 100 ns. \overline{MR} may be driven from an external logic circuit since it is TTL/CMOS compatible. The minimum \overline{MR} input pulse is 1 μ s for $V_{DD}1 = V_{DD}2 = +1.2$ V to +5.5 V. When not in use, the pin is left floating or tied to $V_{DD}1$.

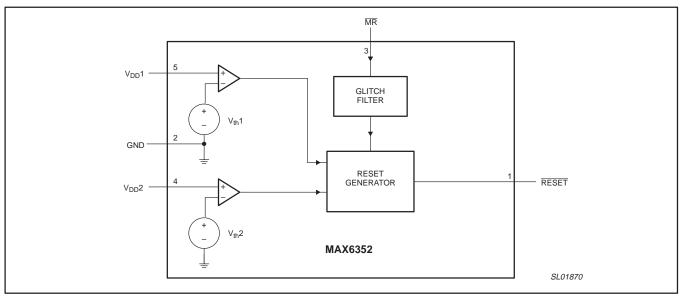


Figure 3. Block diagram.

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TIMING DIAGRAM

The timing diagram in Figure 4 depicts the operation of the device. Letters indicate events on the TIME axis. V_{DD} applies to either V_{DD} 1 or V_{DD} 2.

On power-up, when $V_{\mbox{\scriptsize DD}}$ reaches 1 V, $\mbox{\scriptsize RESET}$ is guaranteed to be a logic LOW.

At Event A, V_{DD} rises to reset threshold voltage, V_{th} . At this time, the internal reset delay timer is initiated. RESET and remains asserted for a reset delay time, t_{RP} of typically 180 ms after the supply voltage rises above the reset threshold, V_{th} .

Event B: At this time, the reset is released. RESET goes HIGH. The reset delay time helps to ensure valid reset signals with erratic changes in supply voltage.

Events C–E: At Event C, under brown-out conditions, V_{DD} falls below the reset threshold minus the hysteresis voltage (typically 20 mV), the reset signal is asserted. When power recovers and V_{DD} rises above the reset threshold, it once again initiates the reset

delay timer (Event D). At Event E, V_{DD} falls below the reset threshold before the reset delay time is reached, and reset remains asserted

At F, the V_{DD} rises above the reset threshold and remains above the reset threshold for typically 180 ms. At G, the reset is once again released.

At H, the \overline{MR} is externally pulled LOW for greater than 1 μs (minimum \overline{MR} pulse width, t_{MR} for V_{DD} = +5 V).

At I, the manual reset is asserted in 100 ns (typical \overline{MR} to reset out delay time, t_{MD} for V_{CC} = +5 V).

At J, the $\overline{\text{MR}}$ pin returns HIGH. At this point, reset delay timer is initiated and in typically 180 ms, (at K), the reset condition is released.

Event L: On power-down, when V_{DD} falls below V_{th} – 20 mV, RESET is guaranteed to be asserted until V_{DD} falls below 1 V.

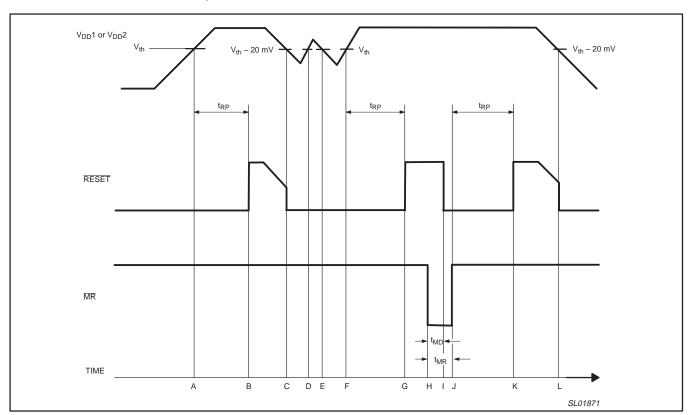


Figure 4. Timing diagram.

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APPLICATION INFORMATION

Negative-going V_{DD} transients

The MAX6352-XX is relatively immune to short duration, negative-going V_{DD} transients or power glitches. This capability greatly reduces false resets with short-duration pulses.

Figure 5, "Maximum V_{DD} transient duration versus reset threshold overdrive", shows the maximum transient condition for which reset signal are not generated. The graph shows the maximum pulse width that a negative-going transient may have before it will generate a reset signal.

Note: As the amplitude of the transient increases, the maximum allowable transient pulse width decreases.

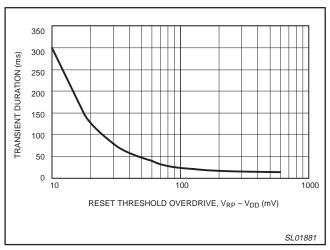


Figure 5. Maximum V_{DD} transient duration versus reset threshold overdrive.

Interfacing to μ Ps with bi-directional RESET pins

The MAX6352-XX RESET output is open drain and is easily interfaced with microprocessors which have bi-directional reset pins, such as the Motorola 68HC11. Directly connecting the MAX6352-XX RESET output to the μP 's reset input and providing a pull-up resistor to V_{DD} allows either device to independently assert reset (Figure 6).

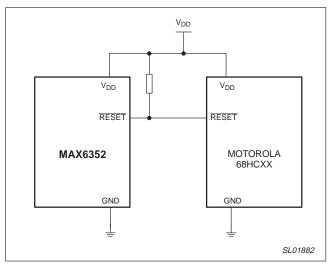


Figure 6. Interfacing to μPs with bidirectional reset I/O.

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PACKING METHOD

The MAX6352-XX is packed in reels, as shown in Figure 7.

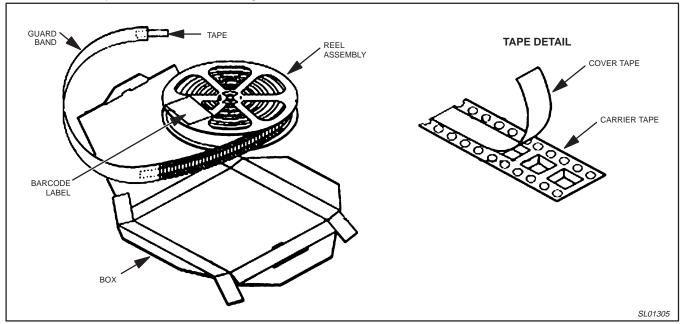


Figure 7. Tape and reel packing method.

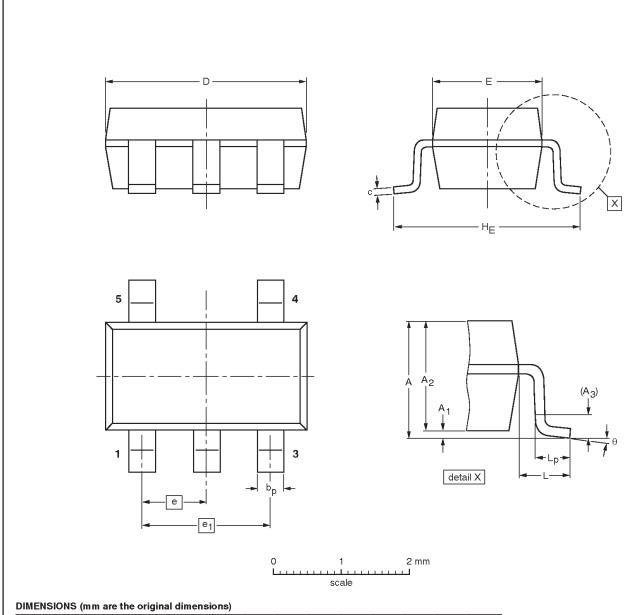
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Plastic small outline package; 5 leads; body width 1.6 mm

SOP003



UNIT	A max.	A ₁	A ₂	A ₃	bр	С	D ⁽¹⁾	E ⁽²⁾	е	e ₁	HE	L	Lp	θ
mm	1.35	0.15 0.05	1.2 1.0	0.25	0.50 0.25	0.22 0.08	3.0 2.7	1.7 1.5	0.95	1.9	3.0 2.6	0.6	0.55 0.35	8° 0°

Notes

- 1. Plastic or metal protrusions of 0.15 mm maximum per side are not included.
- 2. Plastic or metal protrusions of 0.25 mm maximum per side are not included.

OUTLINE		REFER	RENCES	EUROPEAN	ISSUE DATE
VERSION	IEC	JEDEC	JEITA	PROJECTION	ISSUE DATE
SOP003		MO-178			-03-06 -25 03-10-07

Dual voltage microprocessor supervisory IC

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REVISION HISTORY

Rev	Date	Description
_2	20031016	Product data (9397 750 12081). ECN 853-2418 30311 dated 08 September 2003.
		Modifications:
		● Figures 1, 3, and 6 modified: change frame/chassis ground to earth ground symbol.
		Change package outline version to SOP003 in Ordering information table and Package outline sections.
_1	20030801	Product data (9397 750 10608). ECN 853-2418 29712 dated 21 March 2003.

Data sheet status

Level	Data sheet status [1]	Product status ^{[2] [3]}	Definitions
I	Objective data	Development	This data sheet contains data from the objective specification for product development. Phillips Semiconductors reserves the right to change the specification in any manner without notice.
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^[1] Please consult the most recently issued data sheet before initiating or completing a design.

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Limiting values definition — Limiting values given are in accordance with the Absolute Maximum Rating System (IEC 60134). Stress above one or more of the limiting values may cause permanent damage to the device. These are stress ratings only and operation of the device at these or at any other conditions above those given in the Characteristics sections of the specification is not implied. Exposure to limiting values for extended periods may affect device reliability.

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^[2] The product status of the device(s) described in this data sheet may have changed since this data sheet was published. The latest information is available on the Internet at URL http://www.semiconductors.philips.com.

^[3] For data sheets describing multiple type numbers, the highest-level product status determines the data sheet status.